



The Need of Advanced Techniques for Manufacturing

Piezocomposite and Piezoelectric Actuator Design

Emilio Silva and Noboru Kikuchi



Materials Opportunities in Layered Manufacturing Techniques

Cosener's House, Abby Close, Abingdon, Oxfordshire

22-24 June 1998

Major Collaborators

Professor Emilio C.N. Silva

Mechanical Engineering

University of Sao Paulo, Brazil

Professor John Halloran, A.T. Crumm, G.A. Brady

Material Science and Engineering

The University of Michigan

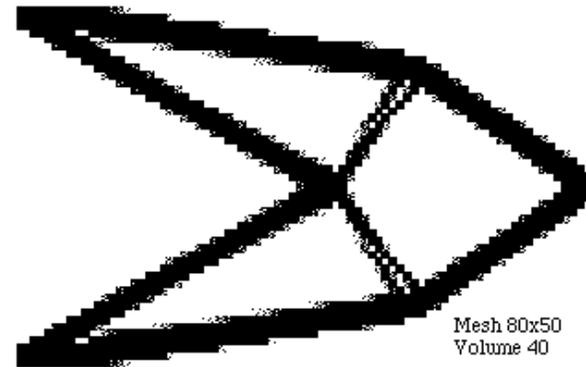
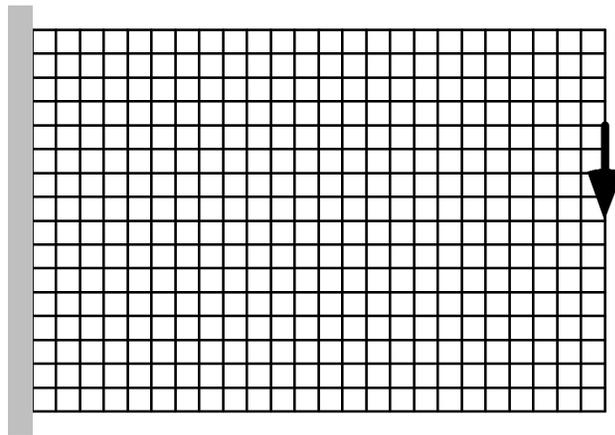
Professor F. Montero de Espinosa

Instituto de Acustica, Madrid, Spain



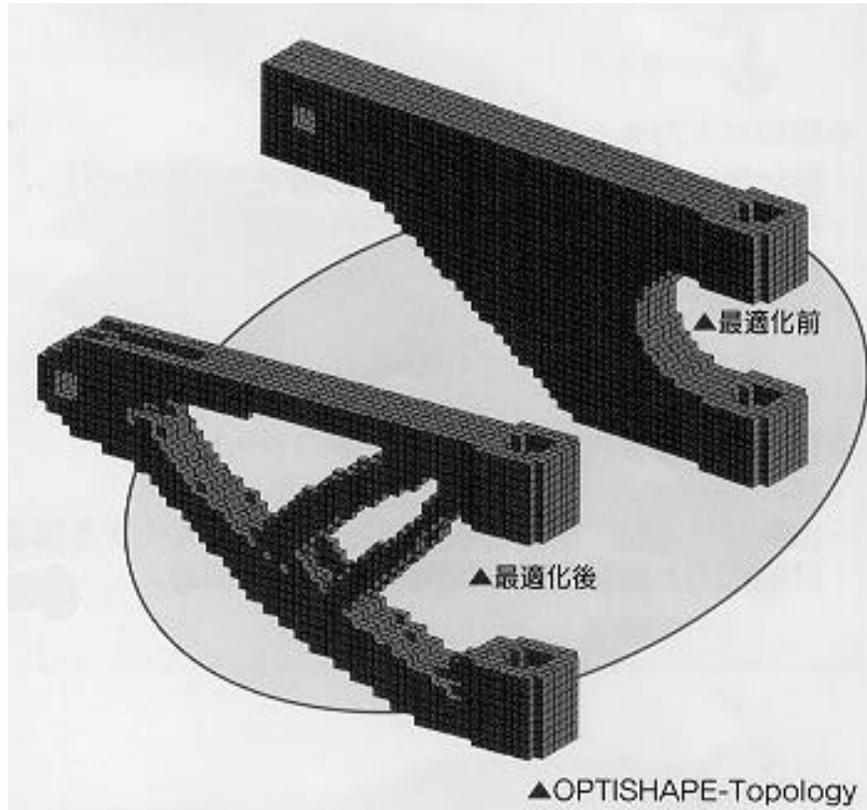
Homogenization Design Method

- Shape and Topology Design of Structures is transferred to Material Distribution Design (Bendsoe and Kikuchi, 1986)

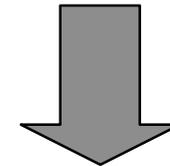




HDM : 3D Shaping



Truly Three-dimensional
shaping of a structure for
optimum



Requirement of emerging
manufacturing methods



Extension of HDM

- Structural Design
 - Static and Dynamic Stiffness Design
 - Control Eigen-Frequencies
 - Design Impact Loading
 - Elastic-Plastic Design
- Material Microstructure Design
 - Young's and Shear Moduli, Poisson's Ratios
 - Thermal Expansion Coefficients
- Flexible Body Design

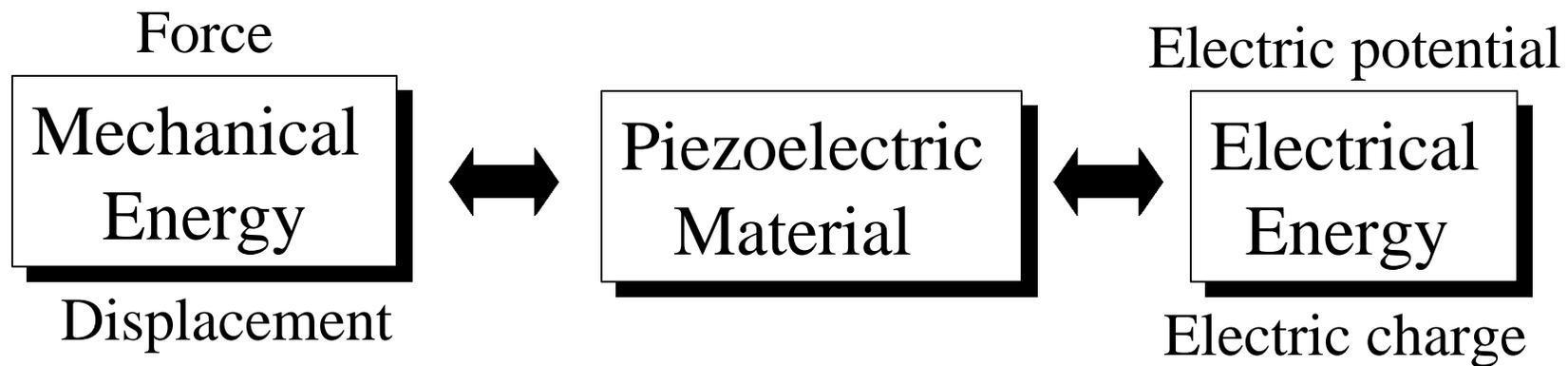


New Extension of HDM

Piezocomposite and Piezoelectric Actuator Design



Introduction



Examples: Quartz (natural)
Ceramic (PZT5A, PMN, etc...)
Polymer (PVDF)



Applications

Pressure sensors
accelerometers
actuators,
acoustic wave generation
 ultrasonic transducers, sonar, hydrophones
etc...



Constitutive Equations of Piezoelectric Medium

$$\begin{cases} T_{ij} = c_{ijkl}^E S_{kl} - e_{kij} E_k & \text{Elasticity equation} \\ D_i = e_{ik}^S E_k + e_{ikl} S_{kl} & \text{Electrostatic equation} \end{cases}$$

T_{ij} - stress

S_{kl} - strain

E_k - electric field

D_i - electric displacement

c_{ijkl}^E - stiffness property

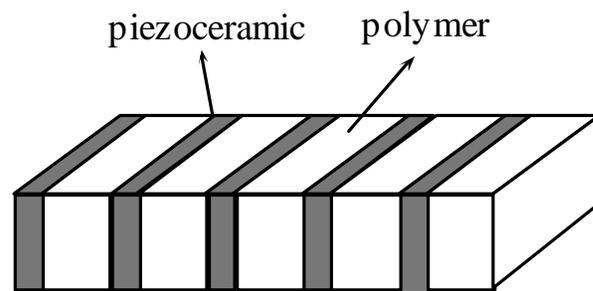
e_{ikl} - piezoelectric strain property

e_{ik}^S - dielectric property

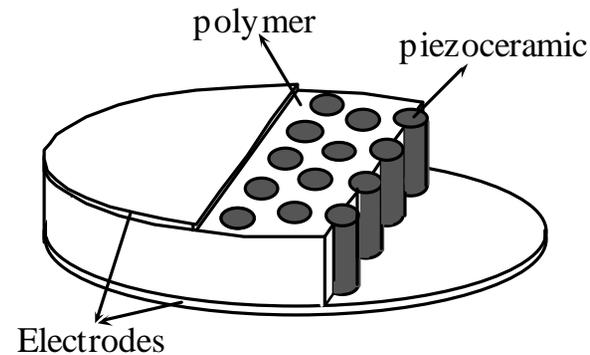
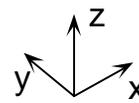


Introduction - Piezocomposites

Combination of a piezoelectric material with other non-piezoelectric materials (ex.: holes)



2-2 piezocomposite

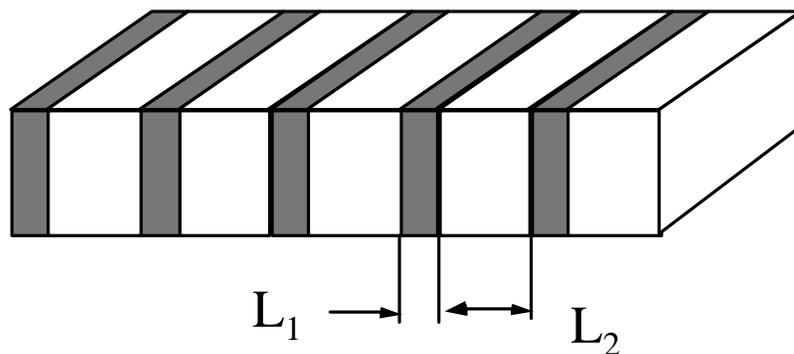


1-3 piezocomposite

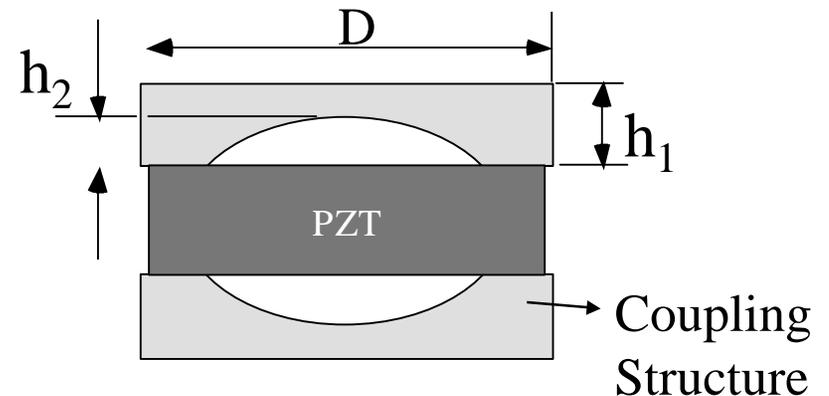
Advantages: high energy conversion, low acoustic impedance, etc...



Design Practice : Parametric



Piezocomposite



Moonie transducer



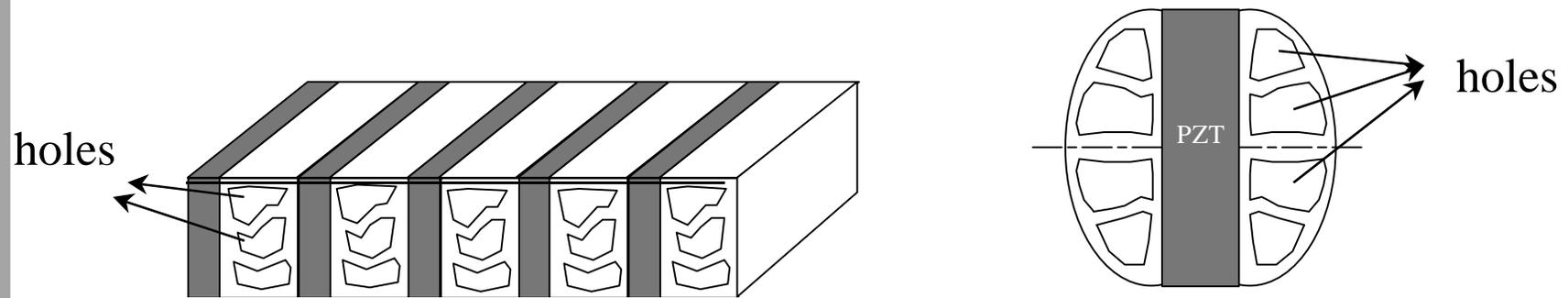
Mathematician Changes Design Practice

Using Parametric Analysis:

- Influence of volume fraction, Poisson's ratio, etc...:
Smith (1993), Avellaneda and Swart (1994)
- Use of negative Poisson's ratio material: Smith (1991),
Avellaneda and Swart (1994)
- Porosity in the matrix polymer: Avellaneda and
Swart (1994)



Topology Design



Topology Optimization

Change the topology of microstructure (material) or structure (transducer)

Improvement in the performance of piezocomposite materials; design of new kinds of transducers for different applications



Many Approaches : HDM

Simple:
Density Method

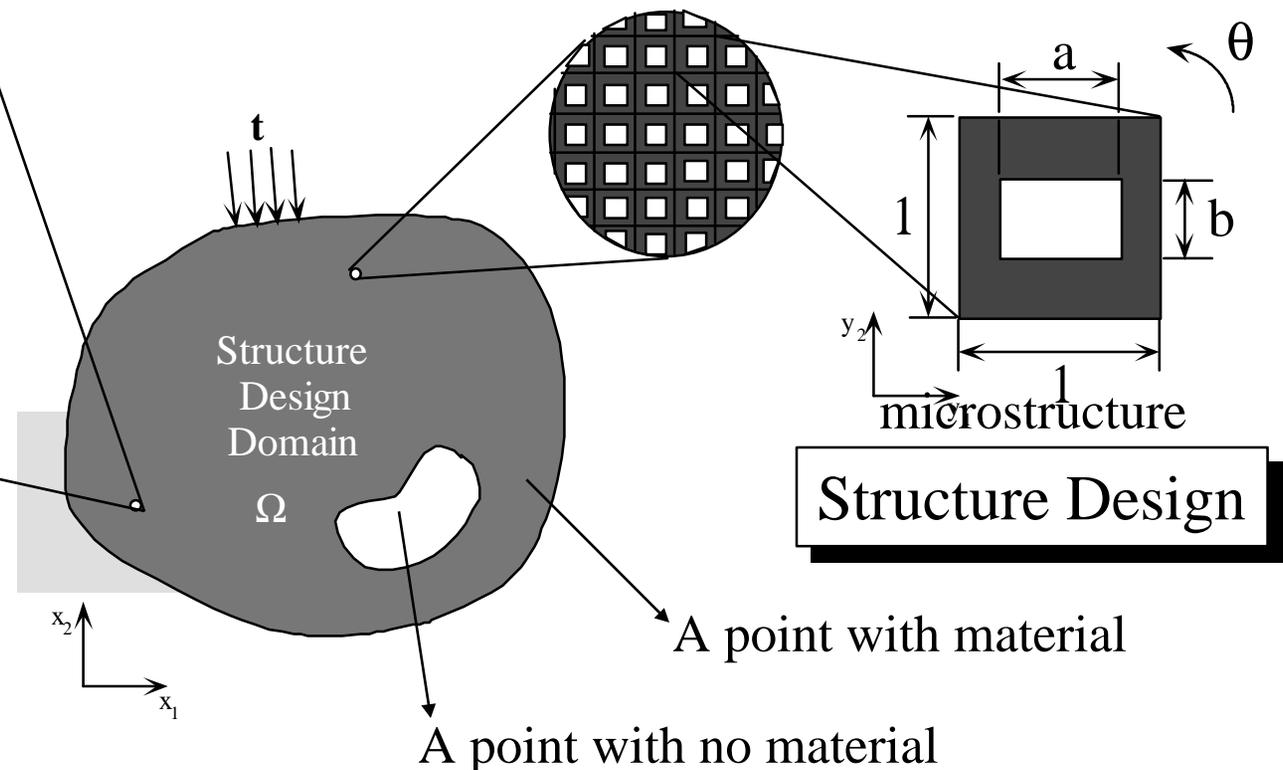
property

$$E_{ijkl} = x^p E_{ijkl}^0$$

fraction of material
in each point

Material Design

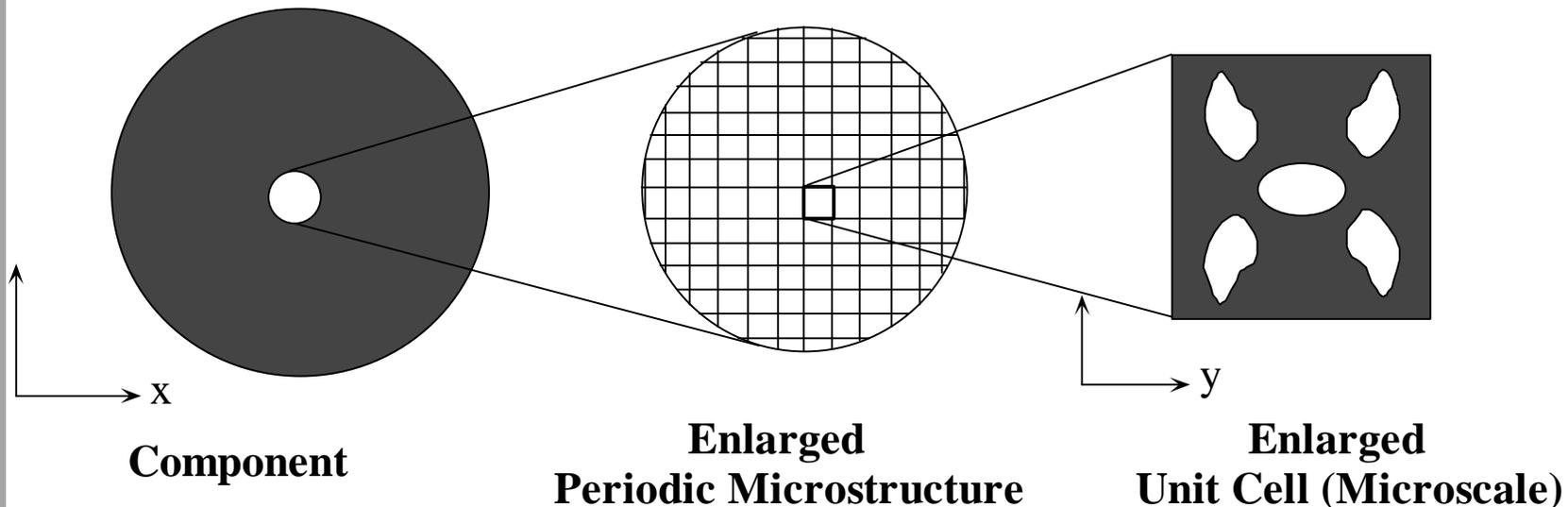
General:
Homogenization Method



Structure Design



Homogenization in Piezoelectricity



- Telega (1990), Galka et al. (1992), and Turbé and Maugin (1991)
- Asymptotic analysis
- Periodic microstructures, scale of microstructure very small compared to the size of the part
- Acoustic wavelength larger than unit cell dimensions



Optimization Problem

Maximize: $F(\mathbf{x})$, where $\mathbf{x}=[x_1, x_2, \dots, x_n, \dots, x_{NDV}]$

\mathbf{x}

subject to: $c_{ijkl}^E \geq c_{low}$, i, j, k, l are specified values

$$0 < x_{low} \leq x_n \leq 1$$

$$W = \sum_{n=1} x_n^p V_n > W_{low}$$

symmetry conditions

$F(\mathbf{x})$ - function of d_h, d_{hg_h}, k_h , or k_t

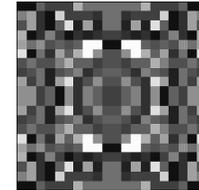
\mathbf{x} - design variables

W - constraint to reduce intermediate densities

(V_n - volume of each element)



**Initializing and
Data Input**



Initial Guess

**Obtaining
Homogenized
Properties**

**Updating
Material
Distribution**

Converged?

Y

Plotting Results

N

**Calculating
Sensitivity**

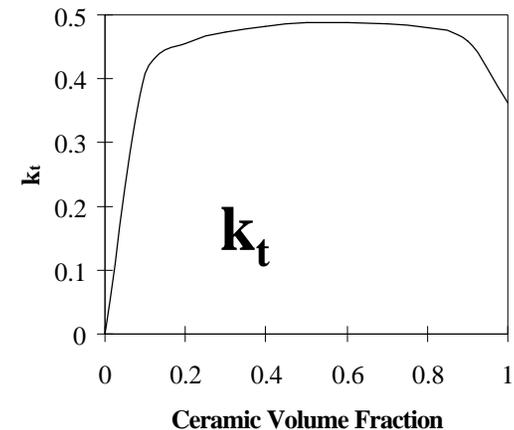
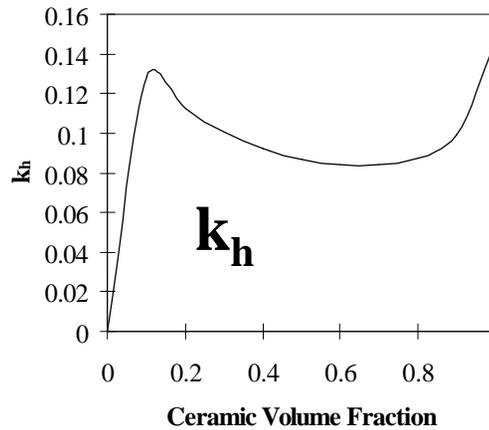
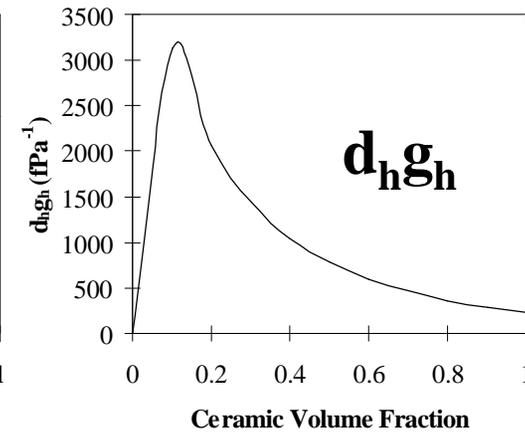
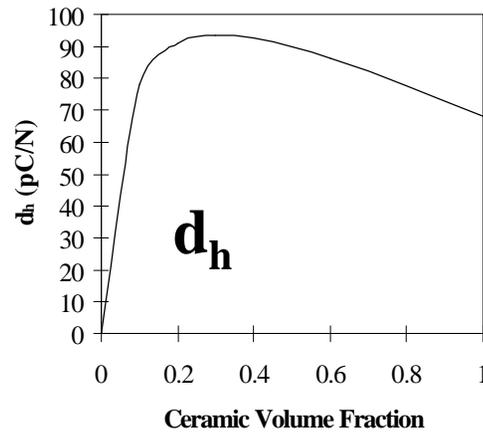
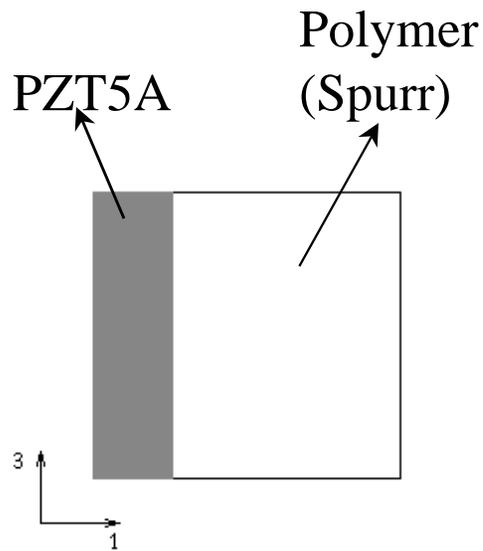
**Optimizing (SLP)
with respect to x**



Final Topology

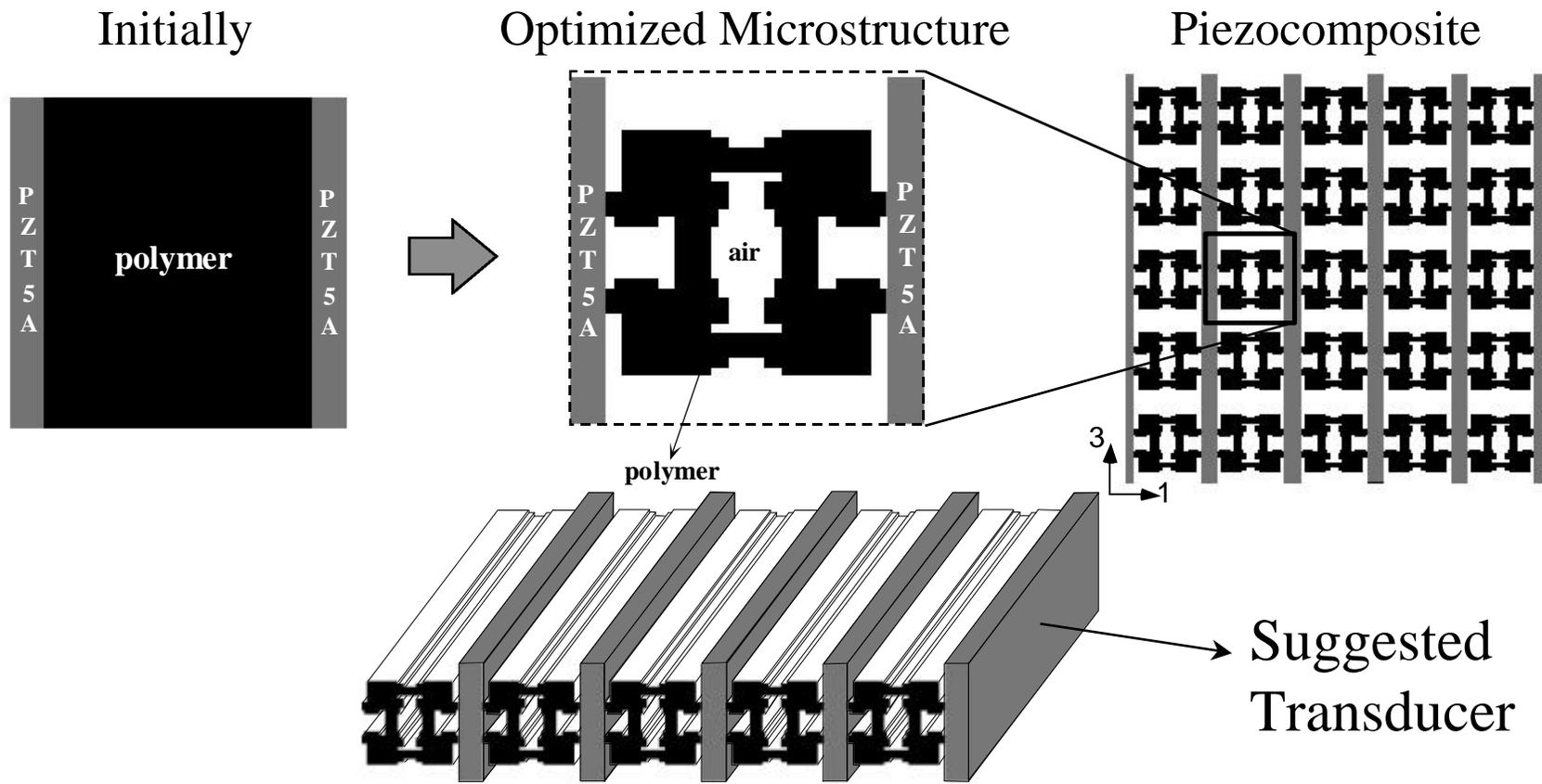


Reference unit cell for comparison: 2-2 piezocomposite





2D Piezocomposite Unit Cell hydrophone





Improvement

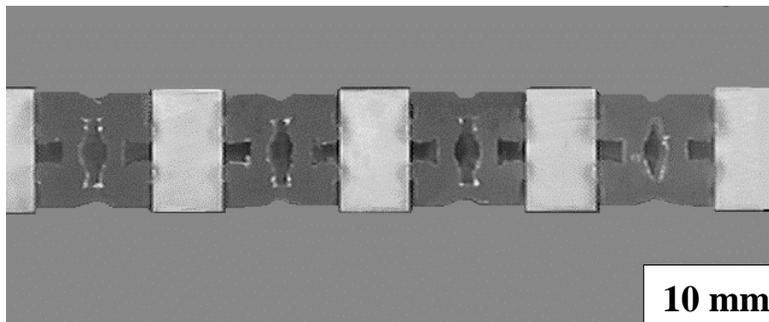
Improvement in relation to the 2-2 piezocomposite unit cell:

$ d_h $: 2.8 times	$\rho \downarrow \Rightarrow Z \downarrow$	$v_t (\cong \text{same})$
$d_h g_h$: 7.1 times		
k_t : 1.13 times	stiffness constraint: $c_{11}^E > 8.10^8 \text{N/m}^2$	

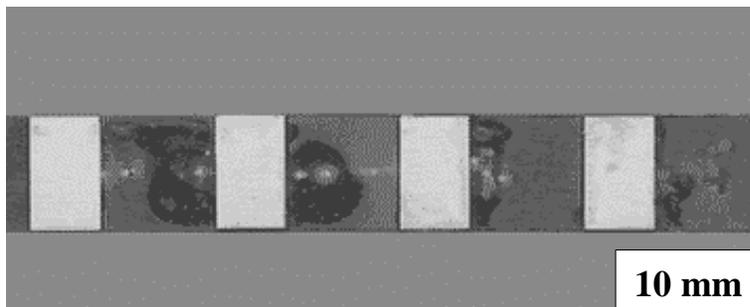


Experimental Verification

- Rapid Prototyping: Stereolithography Technique



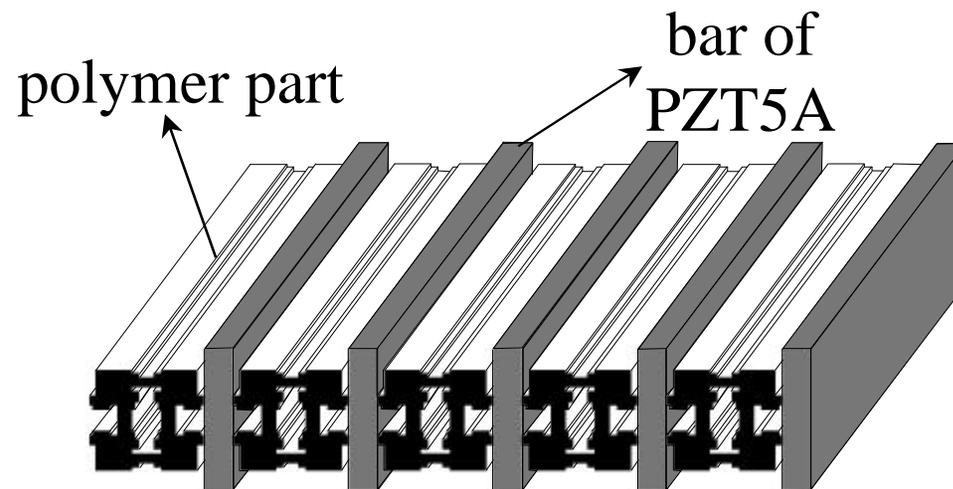
Optimized Transducer



Reference Transducer



Experimental Result



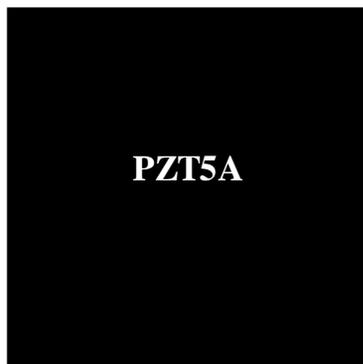
Measured Performances

	d_h (pC/N)	$d_h g_h$ (fPa ⁻¹)	k_t
Reference	9.1	13.2	0.69
Optimized	246.	10400.	0.70
(Simulation)	(229.)	(10556.)	(0.66)

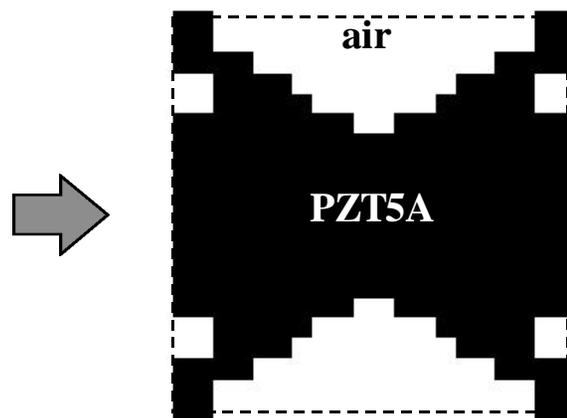


2D Piezocomposite Unit Cell hydrophone

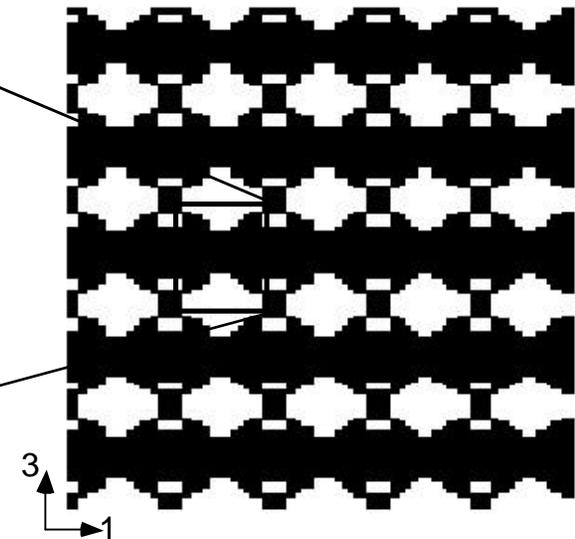
Initially



Optimized Microstructure



Piezocomposite



“optimized porous ceramic”



Improvement

Improvement in relation to the 2-2 piezocomposite unit cell:

$|d_h|$: 3. times

$d_h g_h$: 9.22 times

k_h : 3.6 times

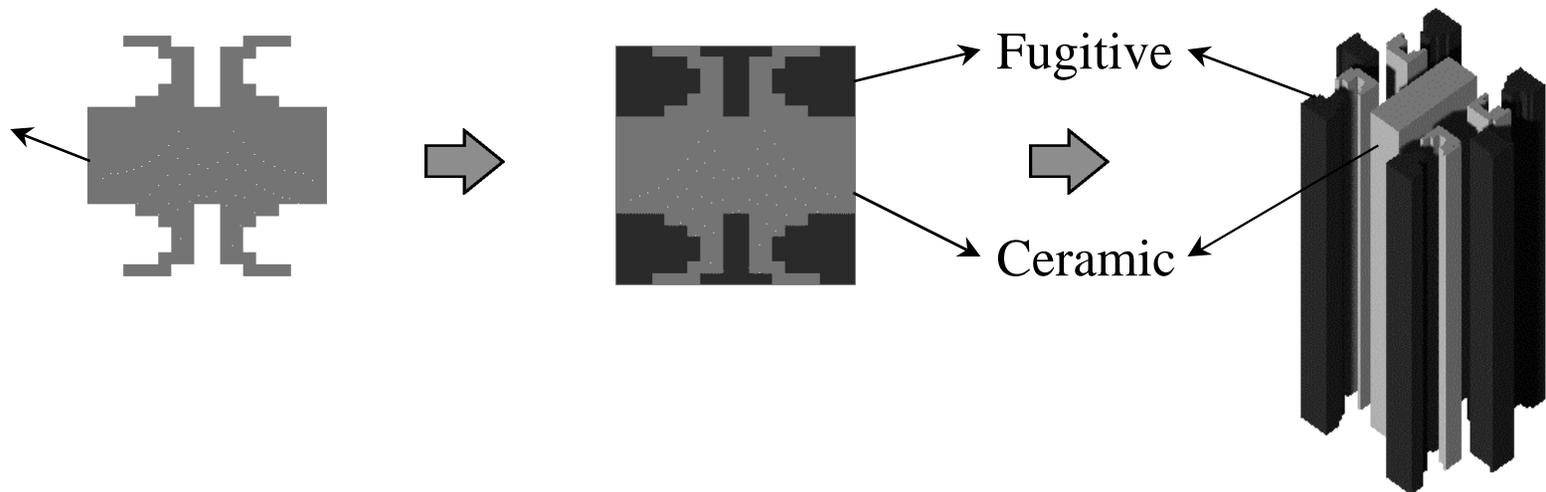
stiffness constraint: $c_{33}^E > 1.10^{10} \text{N/m}^2$

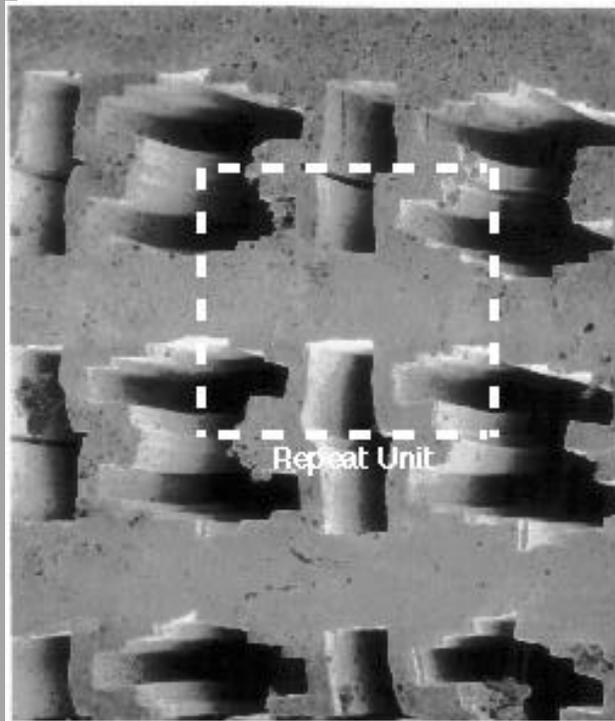


Piezocomposite Manufacturing

Microfabrication by coextrusion technique

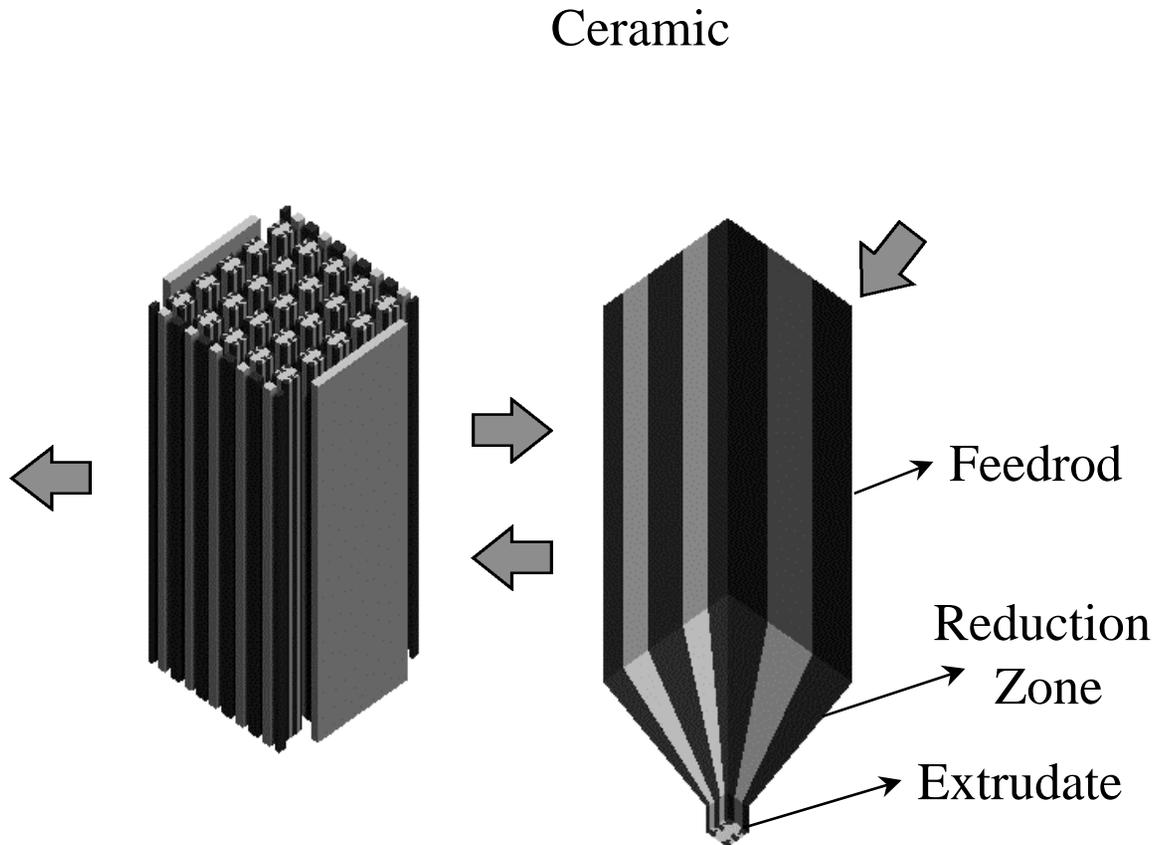
Theoretical
unit cell





SEM Image

250 μm



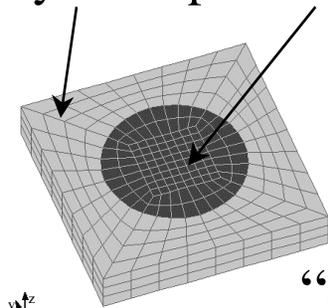
Crumm and Halloran (1997)



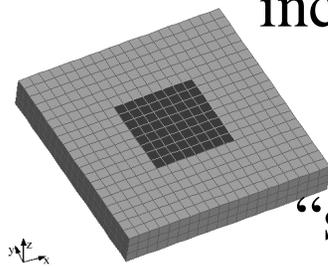
3D Piezocomposite

Reference unit cells: 1-3 piezocomposite

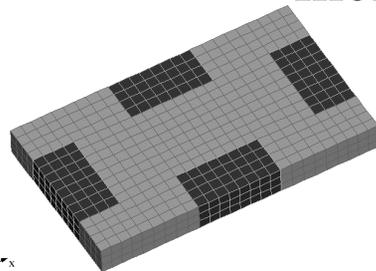
polymer piezoceramic



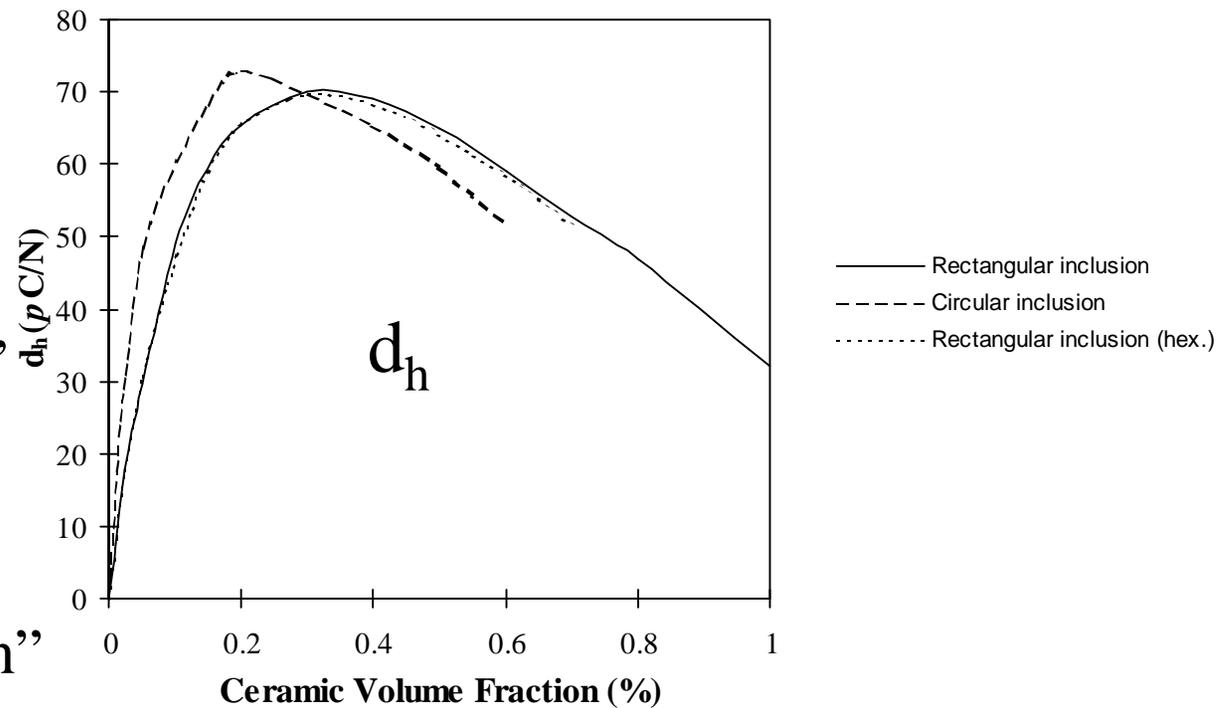
“circular inclusion”



“square inclusion”



“staggered formation”



Similar Behavior for $d_h g_h$, k_h , and k_t

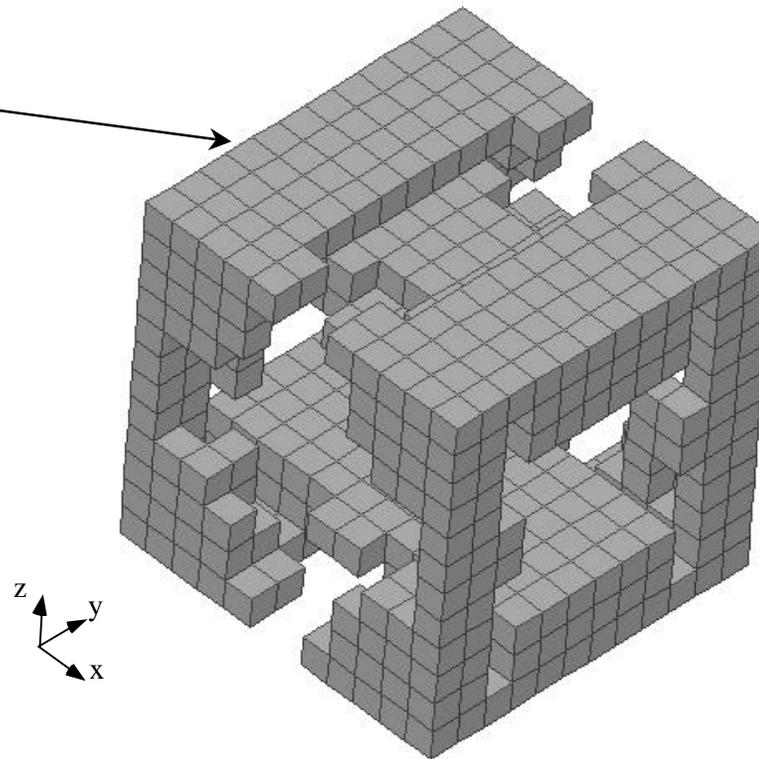


3D Piezocomposite Unit Cell hydrophone

piezoceramic

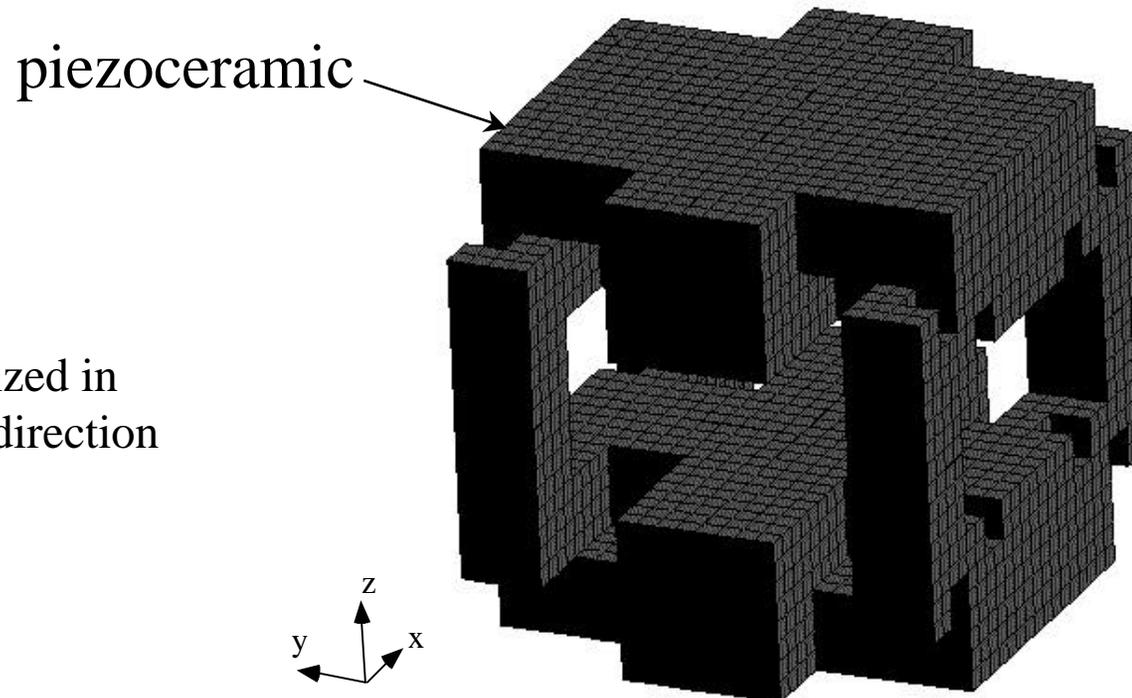


Poled in
the z direction





3D Piezocomposite Unit Cell hydrophone





Summary

**We have shown that
Layered Manufacturing Method
open up possibility of
topology design of piezoceramic composites
and piezoelectric actuators
for large scale performance improvement
by the homogenization design method**